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(12) **United States Design Patent**
Yamada et al.

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(54) **INTERPHONE**

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(73) Assignee: **Aiphone Co., Ltd.** (JP)

(**) Term: **14 Years**

(21) Appl. No.: **29/163,940**

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(30) **Foreign Application Priority Data**

Feb. 27, 2002 (JP) 2002-005060

(51) **LOC (7) Cl.** **14-03**

(52) **U.S. Cl.** **D14/149; D14/159**

(58) **Field of Search** D14/149-151,
D14/143, 144, 241, 130, 329, 330, 243;
379/202, 420.01, 420.02, 420.03, 433.01,
433.02, 433.03, 434, 436

(56) **References Cited**

U.S. PATENT DOCUMENTS

D318,051 S * 7/1991 Danielson et al. D14/142
D375,094 S * 10/1996 Toh D14/151
D408,817 S * 4/1999 Ishibashi D14/149

OTHER PUBLICATIONS

B.A. Pargh Co., 1992 Spring/Summer, p. 312, phone at right and 2nd from bottom.*

* cited by examiner

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(57) **CLAIM**

The ornamental design for an interphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of the interphone showing our new design;

FIG. 2 is a front elevational view of the interphone of FIG. 1;

FIG. 3 is a left side elevational view of the interphone shown in FIG. 1;

FIG. 4 is a right side elevational view of the interphone of FIG. 1;

FIG. 5 is a rear elevational view of the interphone of FIG. 1;

FIG. 6 is a top plan view of the interphone of FIG. 1; and, FIG. 7 is a bottom plan view of the interphone of FIG. 1.

1 Claim, 3 Drawing Sheets

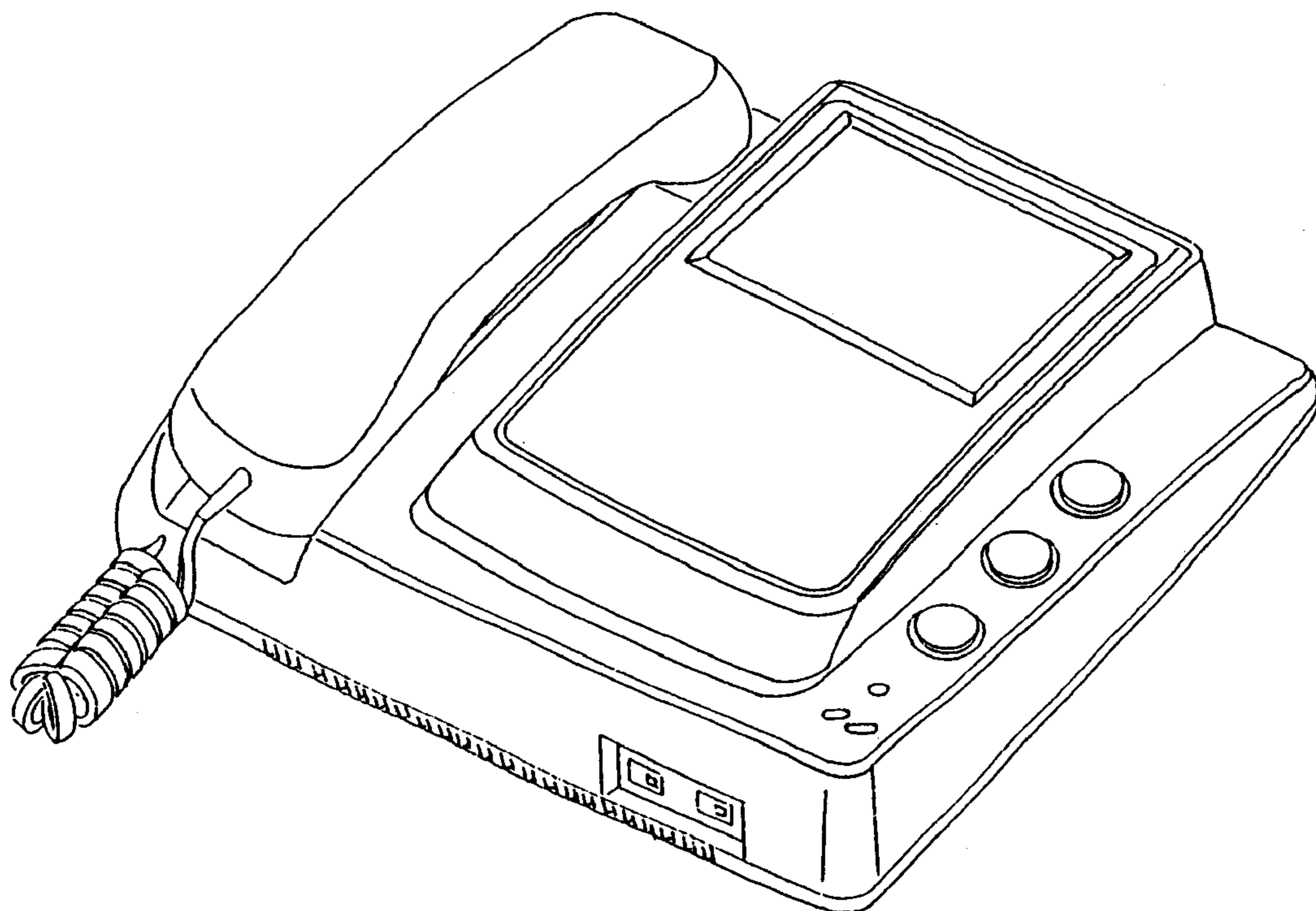


FIG. 1

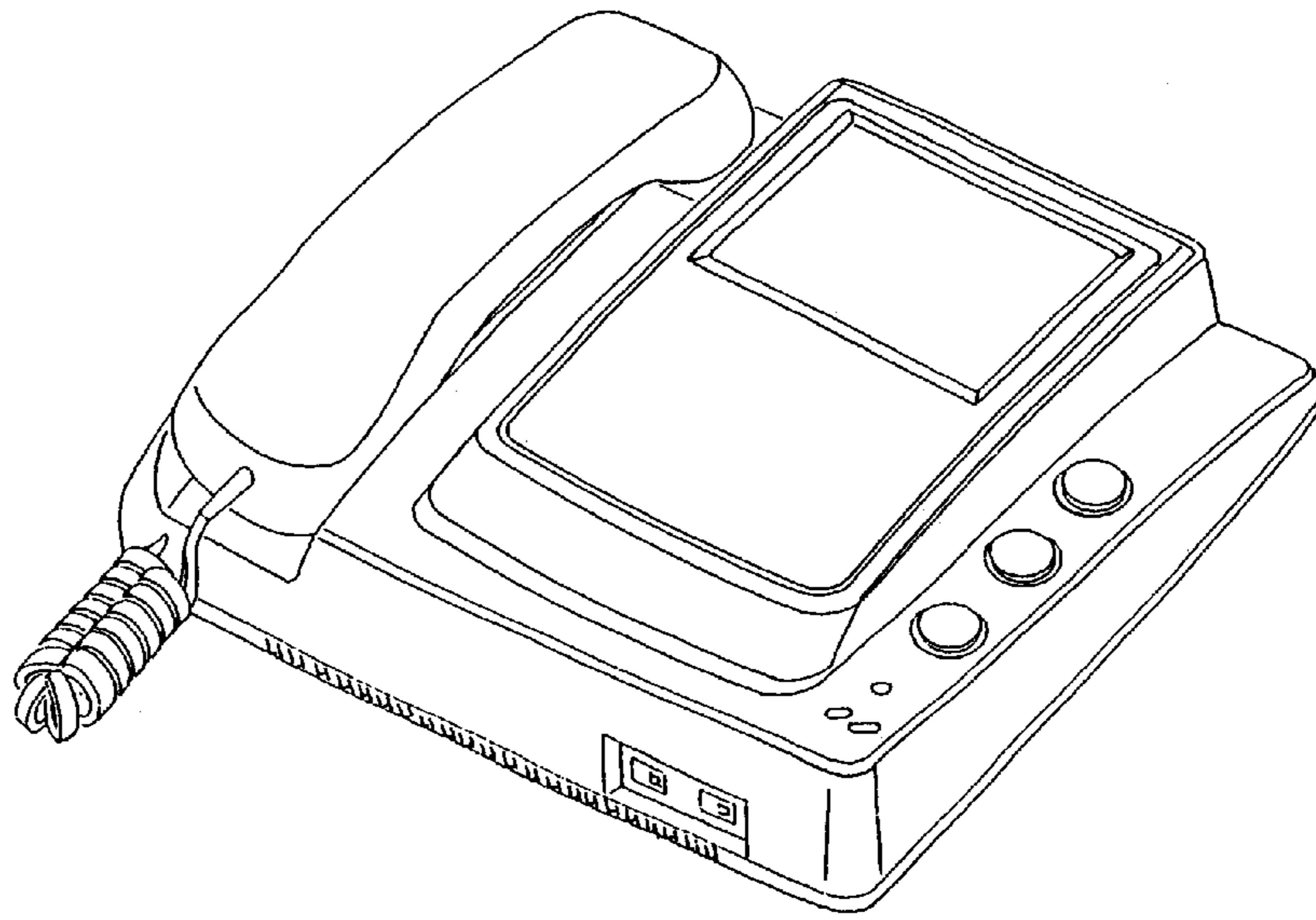


FIG. 2

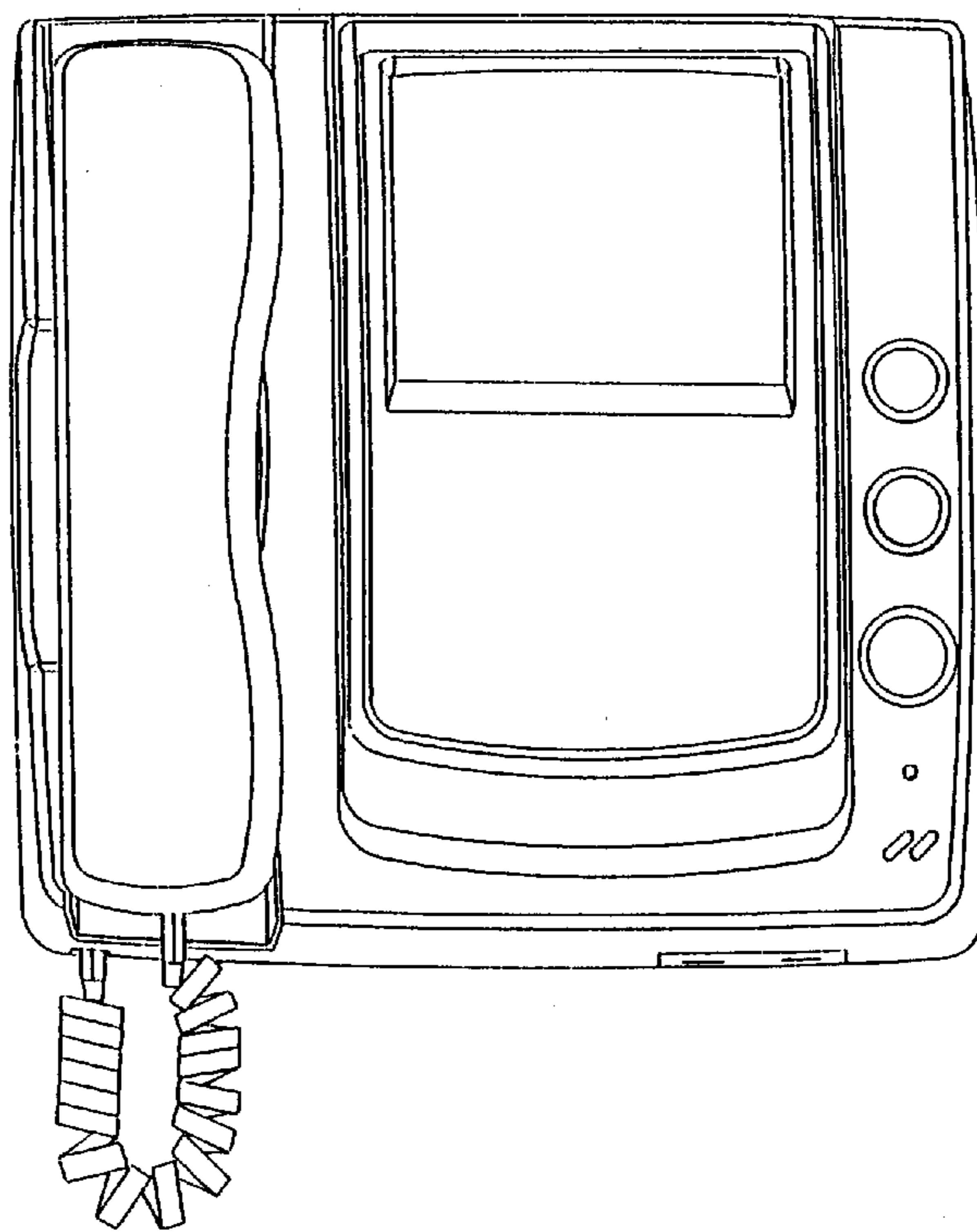


FIG. 3

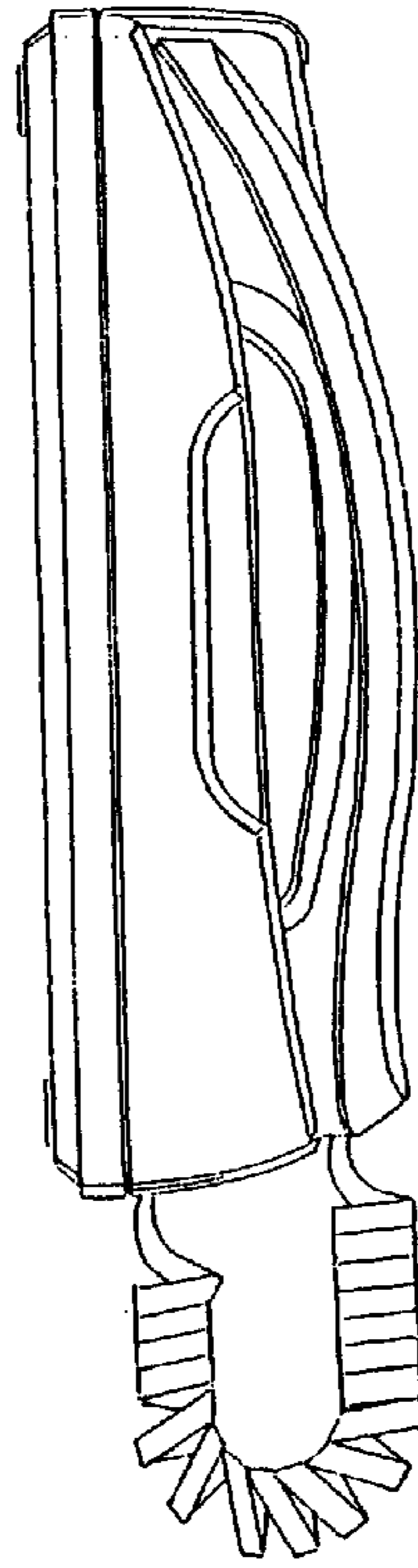


FIG. 4

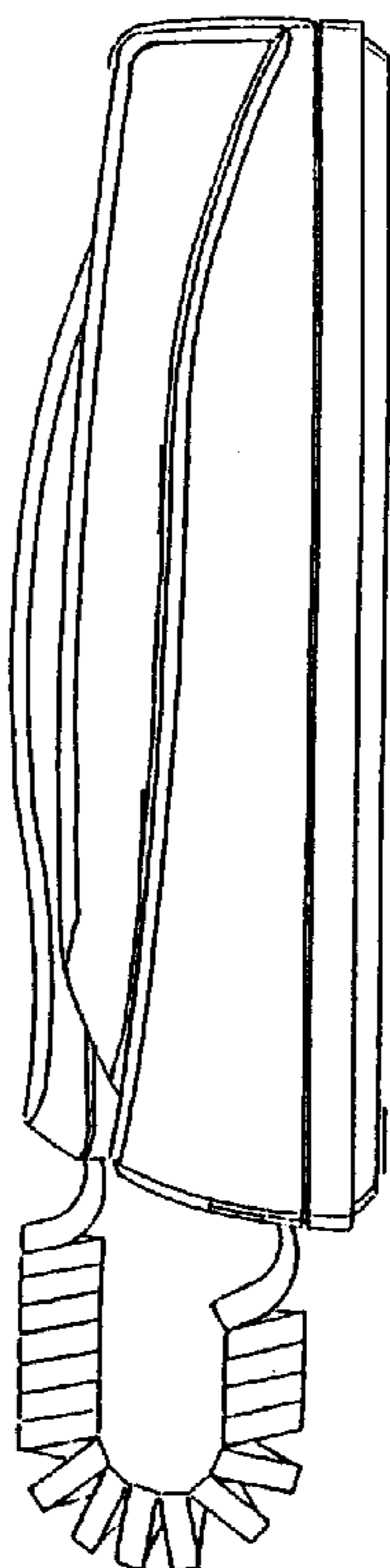


FIG. 5

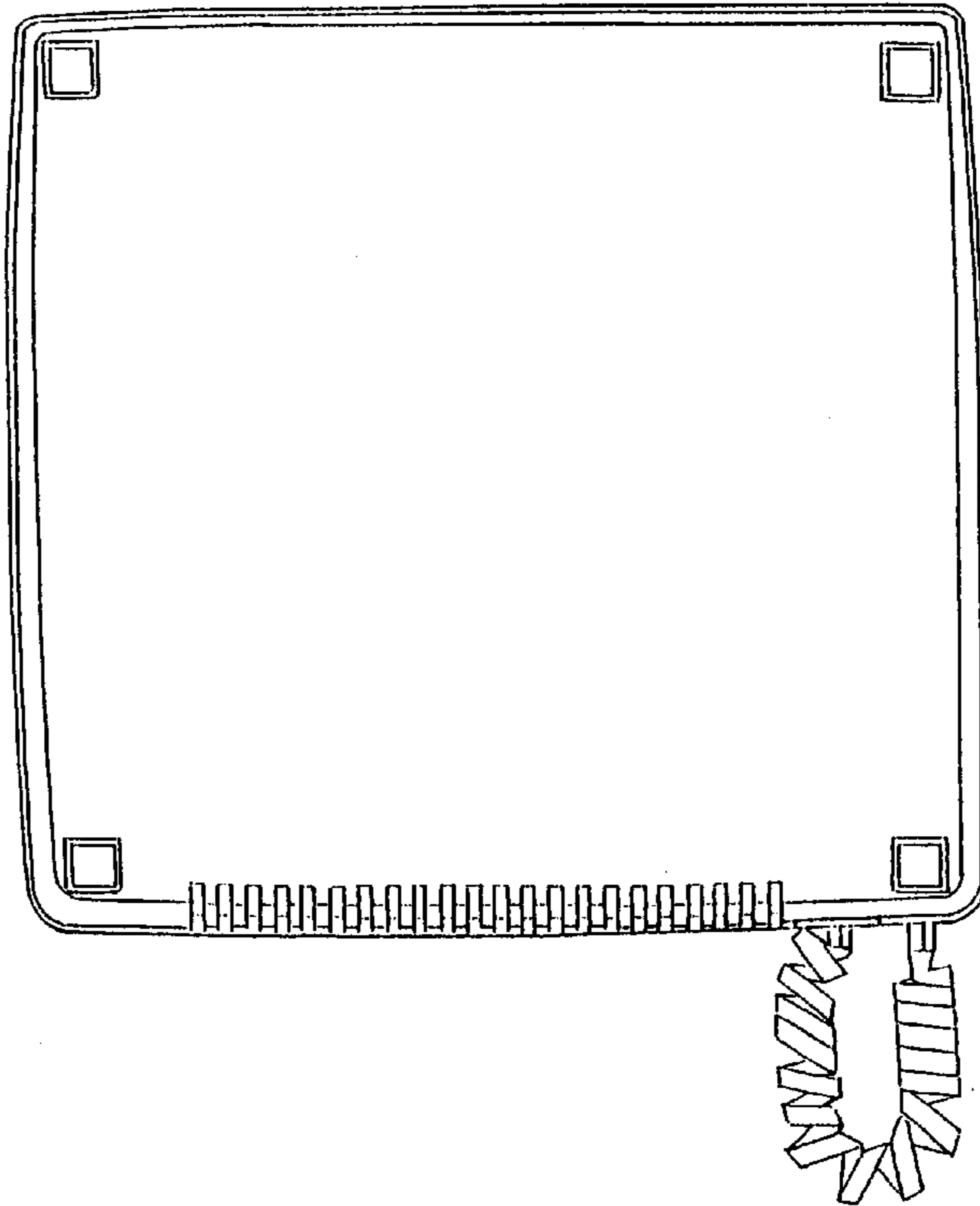


FIG. 6

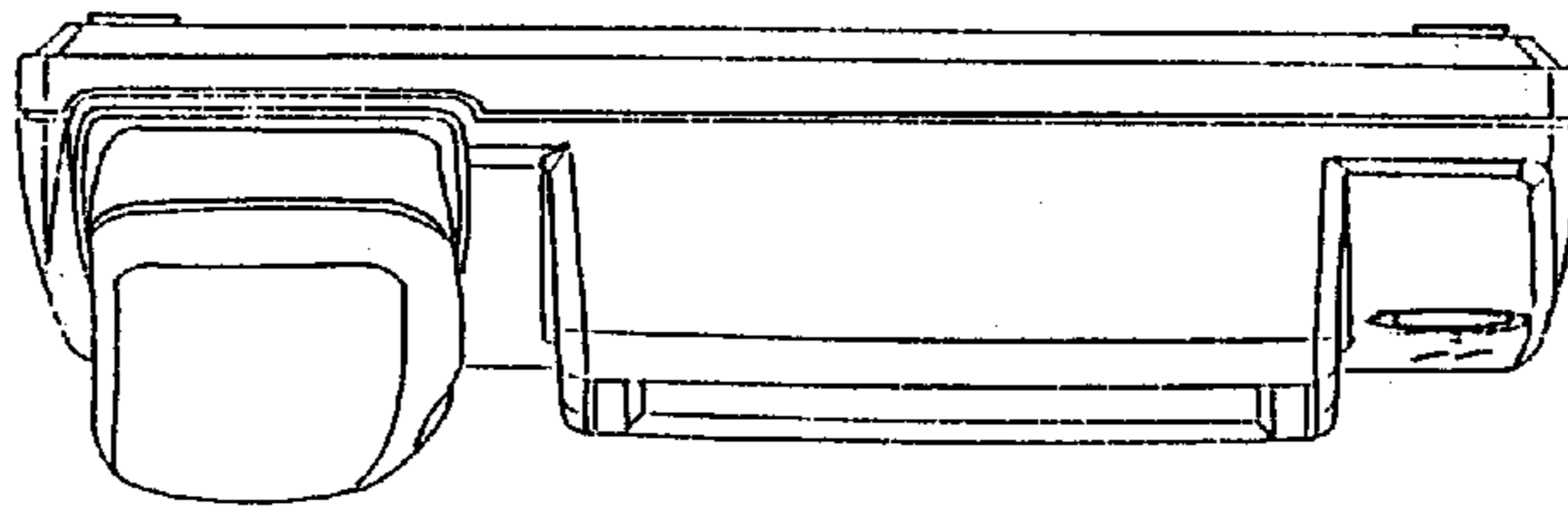


FIG. 7

